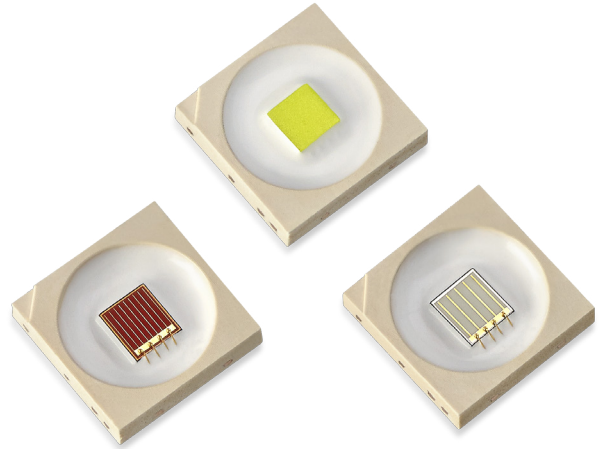


# SFT-10 LED Chipset in SMT and Starboard Configurations



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## Features:

- Matched R/CG/B Chipset with 1.0mm<sup>2</sup> emitting area designed for mid to high current-density 0.2" / 0.3" Pico projection applications
- Thermally efficient SMT Package:  $R_{TH\ J-C} = 3.0^{\circ} C/W$
- Available either in "Standard" (SMT) or Pre-Mounted "Starboard" Configurations
- Available "Starboard" Packaging Configuration allows ease of evaluation and/or immediate system integration
- 100% surface emission for high collection efficiency and low optical losses
- Wide color gamut with the most desirable dominant wavelengths:  
Red-Amber 613 nm, Converted Green (filtered spectrum) 555nm, and Blue 455 nm
- Single emitting area per color allows for efficiency of collection with simplified optics
- Environmentally friendly: RoHS and REACH compliant
- Characterized correlation between "Test" and real-world Display applications are provided.

## Applications

- Specifically engineered for stand alone, embedded, or battery-assisted projection display applications.
- Entertainment / Stage Lighting
- Medical / Life Science
- Industrial
- Transportation / Beacons
- High performance illumination

## Technology Overview

Luminus Devices' SFT series of illuminators is an innovative small form factor solid-state light source created for applications requiring high current density in a small area. With its thermally efficient package, the SFT-10 chipset allows the end-product to deliver all the benefits of small, high performing solid state light sources.

The SFT series is environmentally friendly (Mercury-free), enables instant start and re-start with no wait time, high reliability, and long life requiring no end-user or field replacement. Response time is quick enabling frame-by-frame color control with compatible ASIC control chipsets for projection applications.

### Innovative Packaging Technology

Thermal management is critical in high power LED applications. With a low thermal resistance from junction SFT-10 LEDs can be driven at higher current densities while maintaining a low junction temperature, thereby resulting in brighter solutions and longer lifetimes.

### Reliability

SFT-10 has passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been fully qualified for use in high power / small form factor / high current applications pico applications.

With very low failure rates and median lifetimes that typically exceed 60,000 hours, Luminus SFT-Series LEDs are ready for even the most demanding applications. (Please refer to Luminus' Reliability application note for more information.)

### Environmental Benefits

Luminus LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All LED products manufactured by Luminus are RoHS and REACH compliant and free of hazardous materials, including lead and mercury.

## Understanding SMT Test Specifications

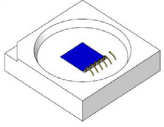
Every Luminus LED is tested to ensure that it meets the high quality standards expected from Luminus' products.

### Testing of SMT LEDs


The Luminus SFT series of products are measured in such a way that allows high volume / fast paced (single pulse) production but accurate measurement that correlates with real world operating conditions.

Luminus makes available to its customers correlation curves (page 8) that allow one to predict with significant accuracy performance in typical "Display" applications.

**Ordering Information (SMT Configuration)<sup>1,3</sup>**

Ordering Part Number <sup>1,3</sup>	Color	Min Flux Bin <sup>2</sup>	Description	Configuration
SFT-10-RA-F35-MPA	Red Amber	1A	Red-Amber LED consisting of a 1.0 mm <sup>2</sup> die mounted on a small 3.5 x 3.5mm high-performance package with directional indicator.	
SFT-10-CG-F35-MPC		Converted Green		
SFT-10-CG-F35-MPD	2D			
SFT-10-B-F35-EPC	Blue	4C	Blue LED consisting of a 1.0 mm <sup>2</sup> die mounted on a small 3.5 x 3.5mm high-performance package with directional indicator.	
SFT-10-B-F35-EPD		4D		

**Ordering Information (Starboard Configuration)<sup>1,3,4</sup>**

Ordering Part Number <sup>1,3</sup>	Color	Min Flux Bin <sup>2</sup>	Description	Configuration
SFT-10-RA-R35-MPA	Red Amber	1A	Red-Amber LED consisting of a 1.0 mm <sup>2</sup> die in a small 3.5 x 3.5mm package mounted on a thermally efficient and pedestal, common cathode designed starboard.	
SFT-10-CG-R35-MPC		Converted Green		
SFT-10-CG-R35-MPD	2D			
SFT-10-B-R35-EPC	Blue	4C	Blue LED consisting of a 1.0 mm <sup>2</sup> die in a small 3.5 x 3.5mm package mounted on a thermally efficient and pedestal, common cathode designed starboard.	
SFT-10-B-R35-EPD		4D		

Note 1: Ordering part numbers represent bin kits (group of bins that are shippable for a given ordering part number)

Note 2: See Bin Kit and Flux bin definitions on page 5.

Note 3: Bin Kits are defined by a group of flux or power bins. Only one flux / power bin will be shipped in each individual pack or reel. Each shipment will contain reels of different allowed bins for a specific orderable part number (See page 5)  
Individual Flux or Power bins are not orderable

Note 4: Starboard Configuration are available for sample quantity only. For additional quantity, contact Luminus representative.

**Ordering Part Number Nomenclature**

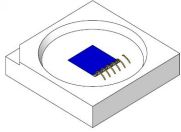

SFT — nn — XXXX — XXX — XYZ

Product Family	Chip Area	Color	Package Configuration	Bin Kit <sup>1</sup>
SFT: Small Flat-Top windowless format	10: 1.0 mm <sup>2</sup>	RA = Red - Amber CG = Converted Green B= Blue	F35: 3.5mm x 3.5mm See Mechanical Drawing section  R35: SFT-10 mounted on Starboard Starboard only in sample quantity	See page 5 for bin kit definition

Note: A Bin Kit represents a group of individual flux or power bins that are shippable for a given ordering part number. Individual flux bins are not orderable.

EXAMPLES: SFT-10-CG-F35-MPC is comprised of Converted Green Flux Bins 2C, 2D, 2E, and 2F,

### PACKAGE CONFIGURATIONS

Package Configuration <sup>1</sup>	Type	Picture	Description
F35	SMT		Standard configuration A 1.0 mm <sup>2</sup> die mounted on a small 3.5 x 3.5mm high-performance package with directional indicator.
R35	STARBOARD		Pre-Mounted Configuration. The standard SFT-10 SMT Package pre-mounted on a Luminus thermally efficient and pedestal, common cathode designed copper 19.9 x 19.9mm starboard. See page 15.  Starboard only in sample quantity. Contact Luminus representative for additional requirements.  Starboard requires electrical isolation in most system designs. Starboard backside is connected to LED cathode.

**Note 1:**

The packaging configuration must be specified within the orderable part number.  
If not specified, or invalid, the order may be rejected or default to the "F35" (Standard) configuration.

### Ordering Part Number Nomenclature

SFT	nn	XXXX	XXX	XYZ
Product Family	Chip Area	Color	Package Configuration <sup>2</sup>	Bin Kit <sup>1</sup>
SFT: Small Flat-Top windowless format	10: 1.0 mm <sup>2</sup>	RA = Red - Amber CG = Converted Green B= Blue	F35: 3.5mm x 3.5mm See Mechanical Drawing section  R35: SFT-10 mounted on Starboard Starboard only in sample quantity	See page 5 for bin kit definition

Note 1: A Bin Kit represents a group of individual flux or power bins that are shippable for a given ordering part number. Individual flux bins are not orderable.  
EXAMPLES: SFT-10-CG-F35-MPC is comprised of Converted Green Flux Bins 2C, 2D, 2E, and 2F,

Note 2: Starboard only in sample quantity. Contact Luminus representative for additional requirements.

### SFT-10 Bin Kit<sup>1</sup> and Flux Bin<sup>3,4</sup> Definitions

Note: Please refer to ordering part number table on page 3 for Bin Kit availability

Red -Amber Flux Bins	Bin 1Z	Bin 1A	Bin 1B	Bin 1C	Bin 1D	Bin 1E	Bin 1F	Bin 1G	Bin 1H		
Red -Amber Bin Flux Range (lm)	80 - 90	90 - 100	100 - 110	110 - 120	120 - 130	130 - 145	145 - 155	155 - 170	170 - 185		
SFT-10-RA-F35-MPA		☑	☑	☑	☑	☑					
Conv Green Flux Bins		Bin 2A	Bin 2B	Bin 2C	Bin 2D	Bin 2E	Bin 2F	Bin 2G	Bin 2H		
Conv Green Bin Flux Range (lm)		200 - 215	215 - 240	240 - 260	260 - 285	285 - 305	305 - 325	325 - 350	350 - 380		
SFT-10-CG-F35-MPC				☑	☑	☑	☑				
SFT-10-CG-F35-MPD					☑	☑	☑	☑			
Blue Power Bins		Bin 4A	Bin 4B	Bin 4C	Bin 4D	Bin 4E	Bin 4F	Bin 4G	Bin 4H		
Blue Optical Power Range (W/mm2)		0.65 - 0.70	0.70 - 0.75	0.75 - 0.85	0.85 - 0.95	0.95 - 1.05	1.05 - 1.15	1.15 - 1.25	1.25 - 1.35		
SFT-10-B-F35-EPC				☑	☑	☑	☑				
SFT-10-B-F35-EPD					☑	☑	☑	☑			

### Wavelength Dominant Bin<sup>2</sup> Definitions

Color	Bin	Minimum WLD (nm)	Maximum WLD (nm)
Red-Amber	R1	609	615
Red-Amber	R2	615	621
Blue	B1	449	455
Blue	B2	455	460

Note 1: Bin Kits are defined by a group of flux or power bins. Only one flux / power bin will be shipped in each individual pack or reel. Each shipment will contain reels of different allowed bins for a specific orderable part number. Individual Flux or Power bins are not orderable.

Note 2: Wavelength bins are not orderable. Wavelength bins are displayed in product label.

Note 3: Packaging configuration must be specified in purchase order. Otherwise, order will either be rejected or default to the "F35" (Standard) configuration. For "StarBoard" configuration, "R35" should be used as package configuration code. Refer to Ordering Part Number Nomenclature on Page 4.

Note 4: SFT-10 LEDs are tested according to the process outlined on page 6. Devices are sorted and packed by flux bin. Not all flux bins are populated. Contact your local LDI representative for current production population.

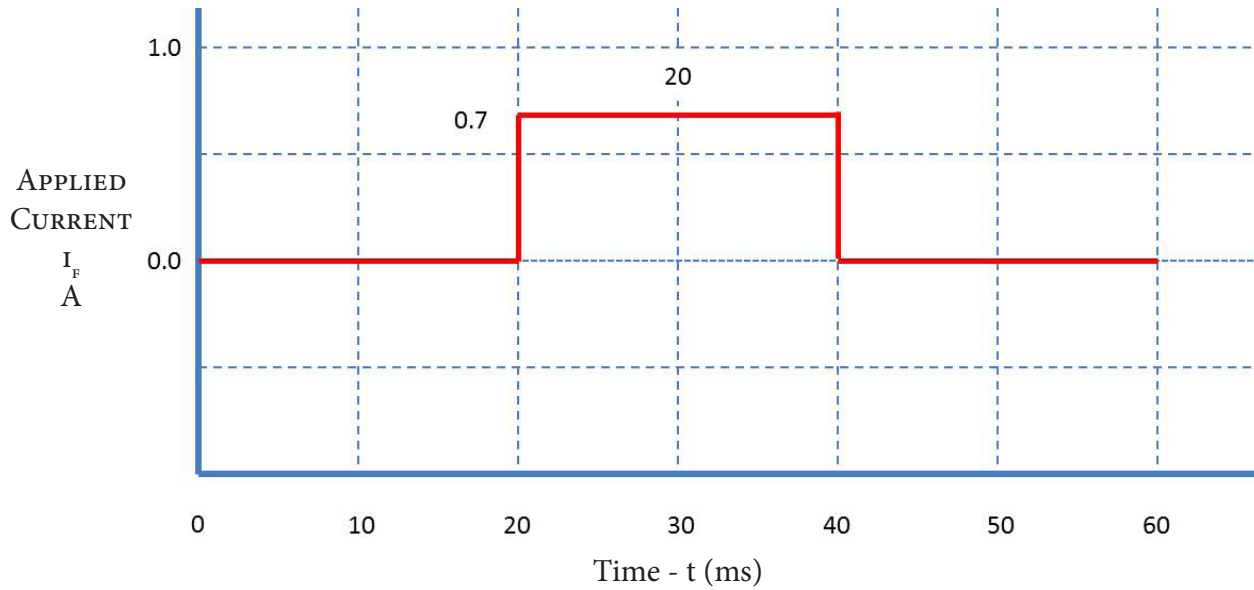
Note 5: Luminus maintains a test measurement accuracy for LED flux and power of +/- 6%.

**STANDARD TEST CONDITION**

All performance metrics of the SFT-Series of LED's are characterized from a single current "PULSE"<sup>1,2,3</sup>

The pulse duration is 20ms, and the applied current is 0.7A.

Rise and Fall times of the signal are negligible.



Note 1: Environmental temperature is assumed to be Ambient. (25C typ)

Note 2: Due to the brief nature of this test,  $T_j$  (Junction Temperature) is assumed to be ambient or approx 25C.

Note 3: Luminus maintains a tolerance of +/- 6% on flux measurements

**Optical & Electrical Characteristics**

General Characteristics		Symbol	Red -Amber	Converted Green	Blue*	Unit
Emitting Area			1.0	1.0	1.0	mm <sup>2</sup>
Emitting Area Dimensions			1.0 x 1.0	1.0 x 1.0	1.0 x 1.0	mm x mm
Performance at Standard Test Conditions (See definition on p5)						
Peak Luminous Flux <sup>1,2,5</sup>	typ	$\Phi_v$	120	259	34	lm
Peak Radiometric Flux <sup>1,2</sup>	typ	$\Phi_r$	0.42	0.55	0.88	W
Dominant Wavelength	min	$\lambda_{dmin}$	609	545	449	nm
	typ	$\lambda_d$	613	555	455	
	max	$\lambda_{dmax}$	621	565	461	
FWHM- Spectral bandwidth at 50% of $\Phi_v$	typ		16	98	19	
Chromaticity Coordinates <sup>6,7</sup>	typ	x	0.66	0.33	0.14	CIE x
	typ	y	0.32	0.56	0.04	CIE y
Forward Voltage	min	$V_{Fmin}$	2.2	2.5	2.5	V
	typ	$V_F$	2.5	3.0	3.0	
	max	$V_{Fmax}$	3.0	3.6	3.6	
Correlated Performance in Typical Display Application (2.5A/mm <sup>2</sup> @ 40C) [Reference Only]. See curves starting on p8.						
Reference Drive Current	typ	$I_F$	2.5	2.5	2.5	A
Reference Duty Cycle	typ		25	50	25	%
Luminous Flux	typ	$\Phi_v$	300	650	100	lm
Radiometric Flux	typ	$\Phi_r$	1.1	1.4	2.0	W
Dominant Wavelength	typ	$\lambda_d$	613	555	453	nm
FWHM -Spectral bandwidth at 50% of $\Phi_v$	typ		15	99	19	
Chromaticity Coordinates <sup>6,7</sup>	typ	x	0.66	0.32	0.14	
	typ	y	0.33	0.55	0.04	
Forward Voltage	typ	$V_F$	3.6	3.5	3.4	V

Note 1: All ratings are based on standard testing conditions unless specified otherwise.

Note 2: Parameters rated at Standard Test condition as defined on page 6.

Note 3: Duty Cycle used to specify device ratings under Pulsed operation. SFT-Series of LEDs can operate at duty cycles ranging from 1% to 100%. At higher duty cycles, drive current should be adjusted to maintain the junction temperature at desired levels to meet the application lifetime requirements.

Note 4: In pulsed operation, rise time from 10 to 90% of forward current should be larger than 0.5 microseconds.

Note 6: CIE 1931 chromaticity diagram coordinates, normalized to X+Y+Z=1.

Note 7: For Reference only.

## Optical & Electrical Characteristics

### Absolute Maximum Ratings

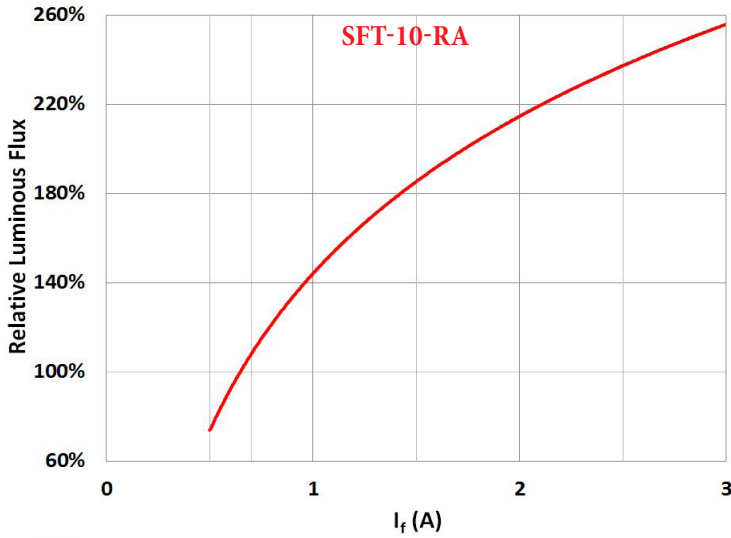
	Symbol	Red - Amber	Converted Green	Blue	Unit
Absolute Minimum Current (CW or Pulsed) <sup>1</sup>		200	200	200	mA
Absolute Maximum Current (CW) <sup>2</sup>		2.5	3.0	3.0	A
Absolute Maximum Reverse Drive Current (CW or Pulsed)		0, REVERSE CURRENT OPERATION IS NOT ALLOWED			
Absolute Maximum Current (Pulsed) <sup>2,3</sup> (Frequency > 240 Hz, duty cycle <70%)		3.0	4.0	4.0	
Absolute Maximum Surge Current <sup>2,3</sup> (Frequency > 240 Hz, duty cycle =10%, t= 1ms)		4.0	4.0	4.0	
Absolute Maximum Junction Temperature <sup>4</sup>	$T_{jmax}$	110	150	150	°C
Storage Temperature Range		-40 / +100	-40 / +100	-40 / +100	

- Note 1: Product performance and lifetime data is specified at recommended forward drive currents. Sustained operation at or near absolute minimum currents may result in a reduction of device performance and device lifetime compared to recommended forward drive currents.
- Note 2: Sustained operation above maximum currents is not recommended and will result in a reduction of device lifetime compared to specified maximum forward drive currents. Device lifetimes will depend on junction temperature. (See Reliability Application Note, APN-001444 for product lifetimes as function of junction temperature.) Please refer to lifetime de-rating curves (available from Luminus) for further information.
- Note 3: In pulsed operation, rise time from 10 to 90% of forward current should be larger than 0.5 microseconds.
- Note 4: Sustained operation at Absolute Maximum Operating Junction Temperature ( $T_{jmax}$ ) will result in reduced device life time.

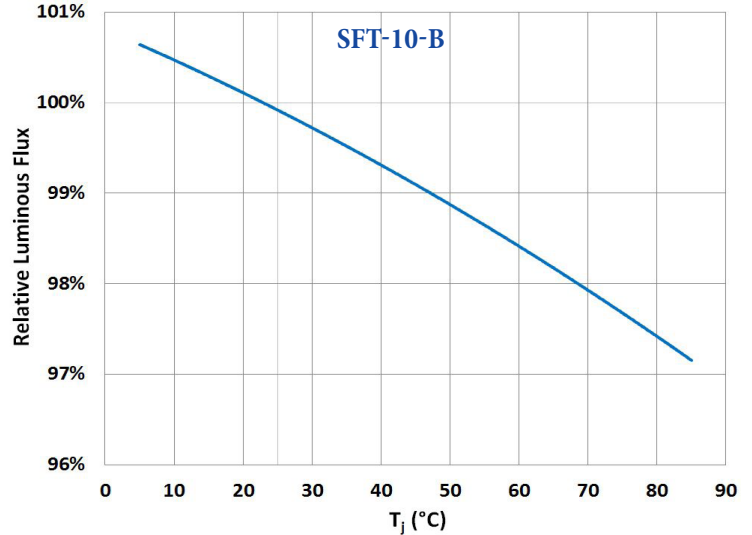
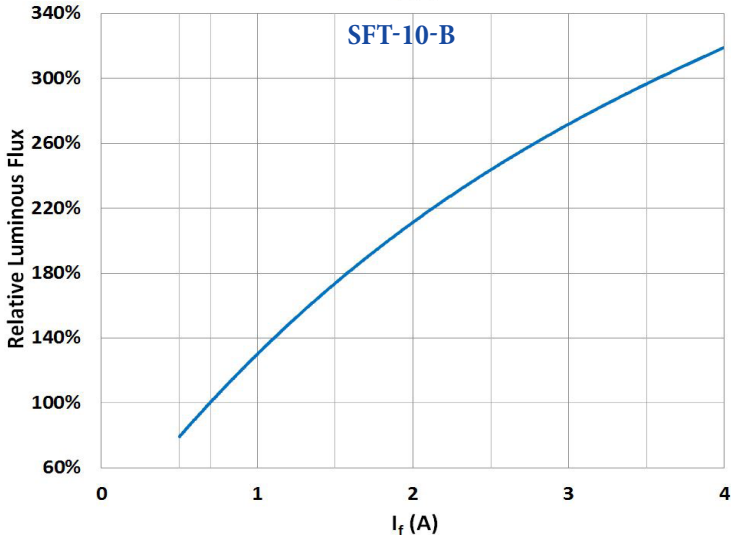
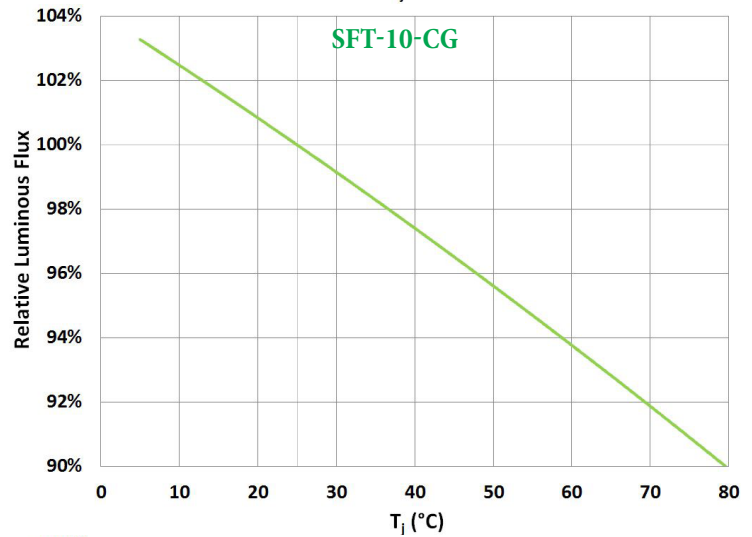
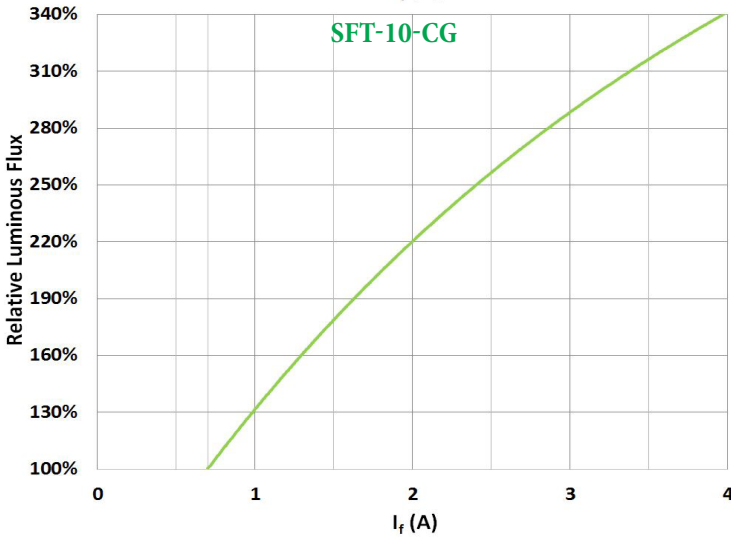
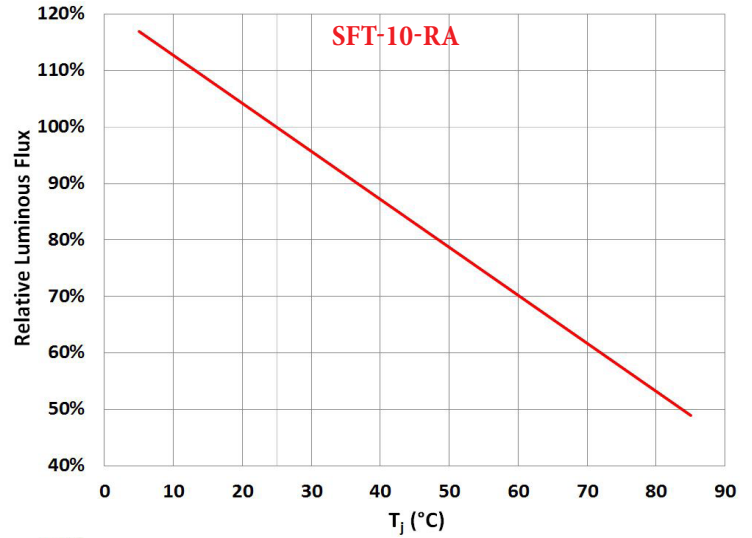


### Normalized Luminous Flux

vs. Forward Current ( $T_{hs} = 25^{\circ}\text{C}$ ,  $I_f = \text{Pulse}$ )

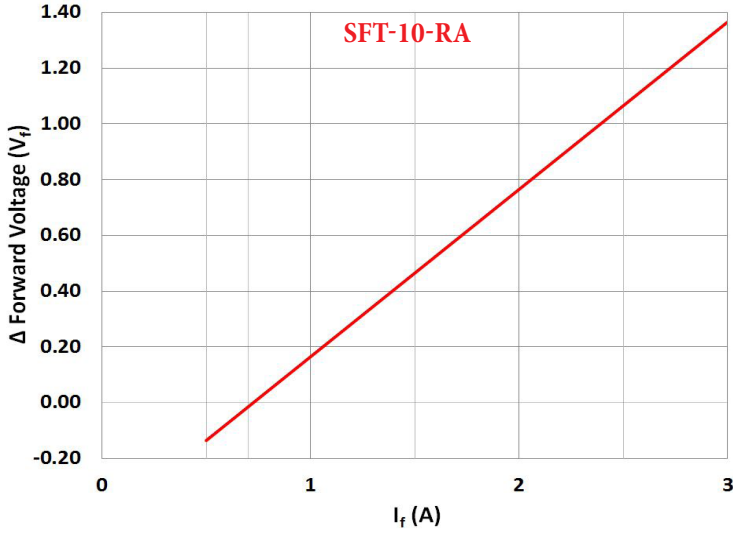


vs.  $T_j$  ( $I_f = 0.7\text{A}$  Pulse)

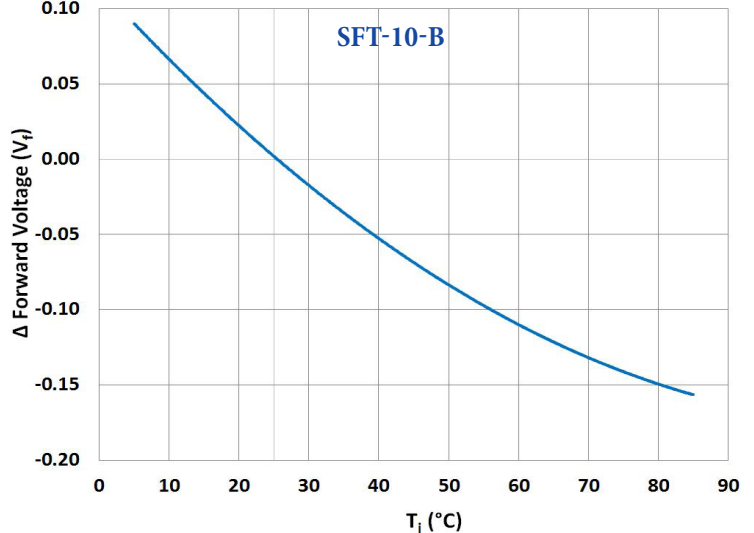
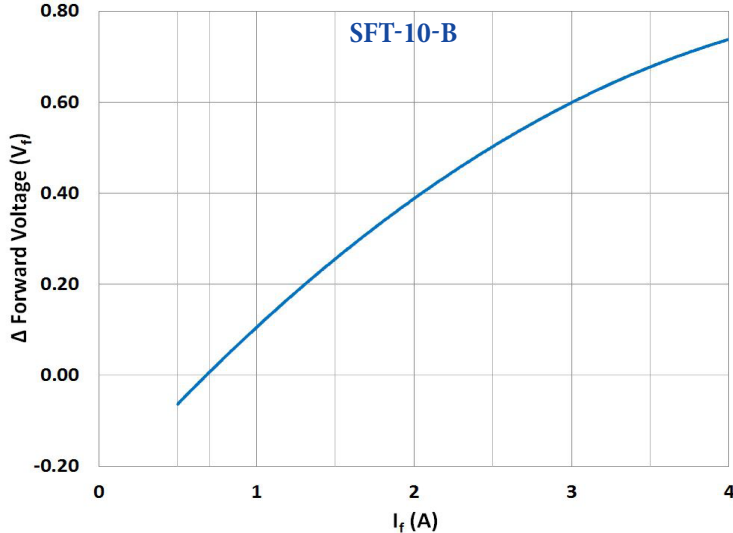
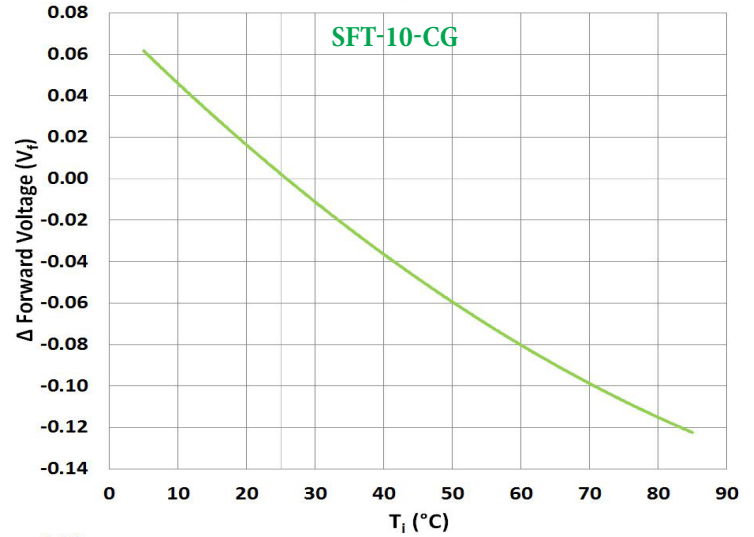
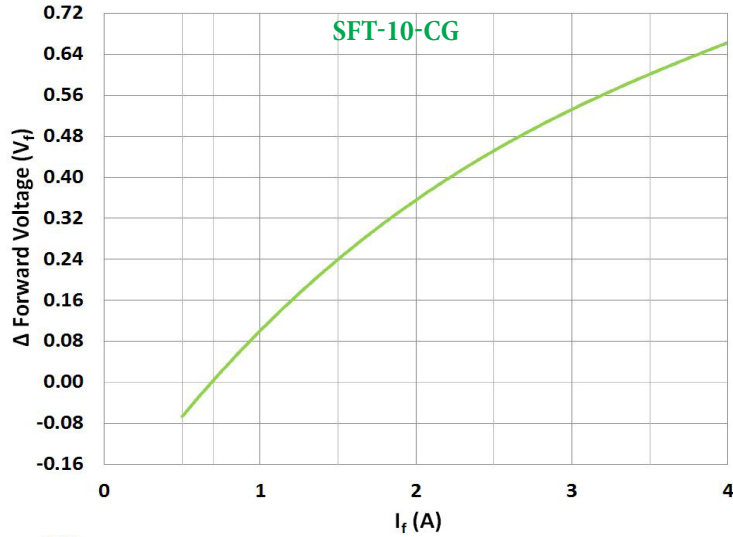
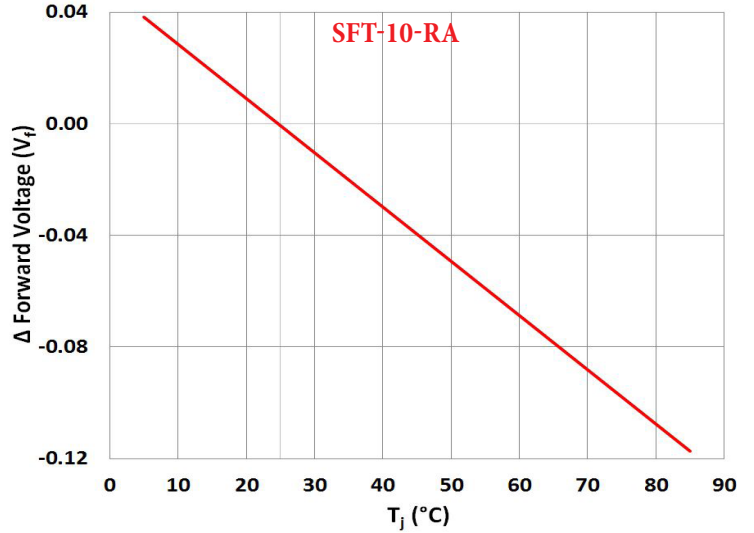


### Relative Forward Voltage

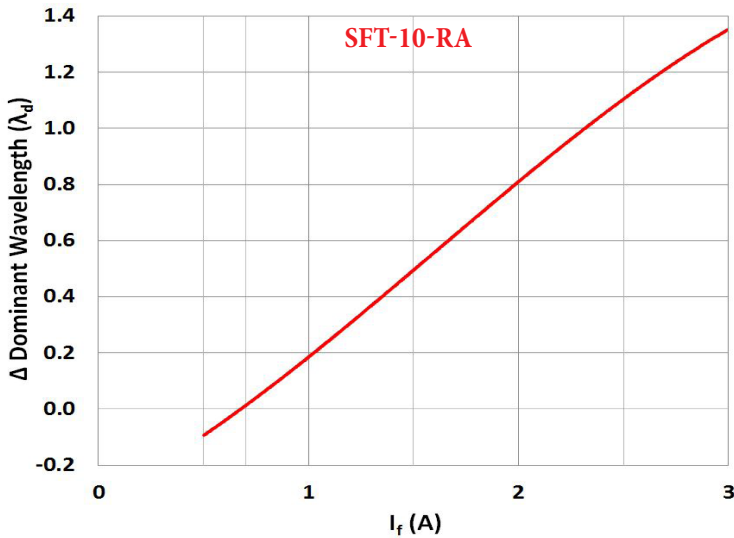
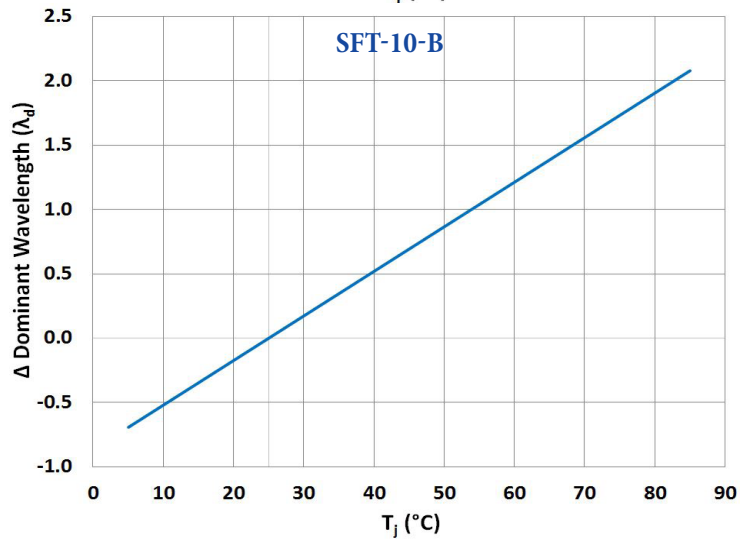
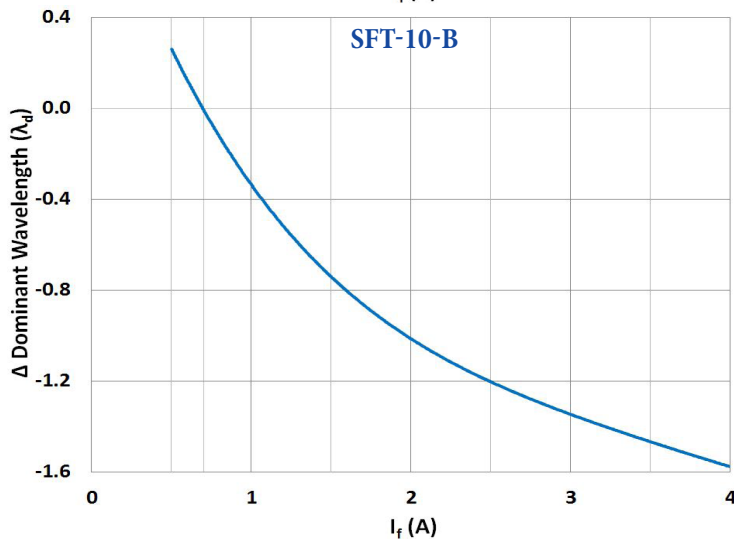
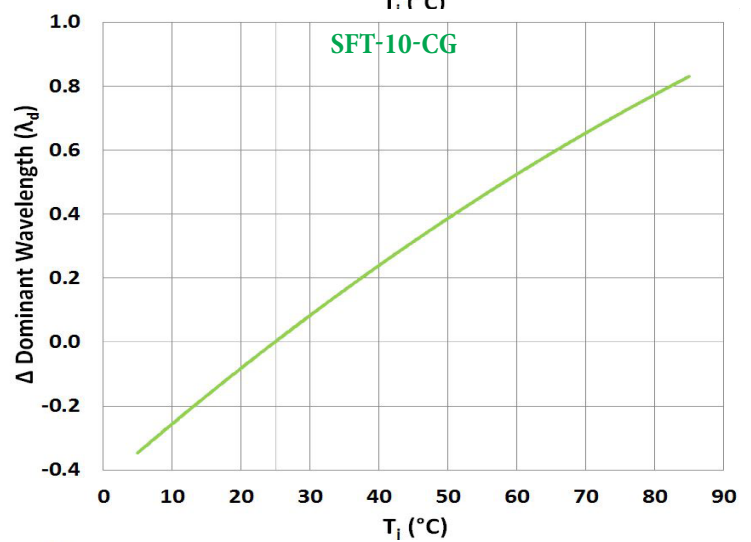
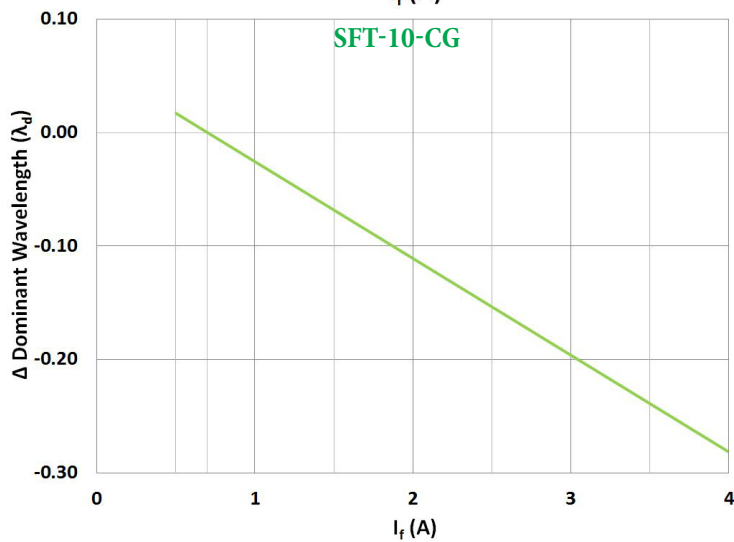
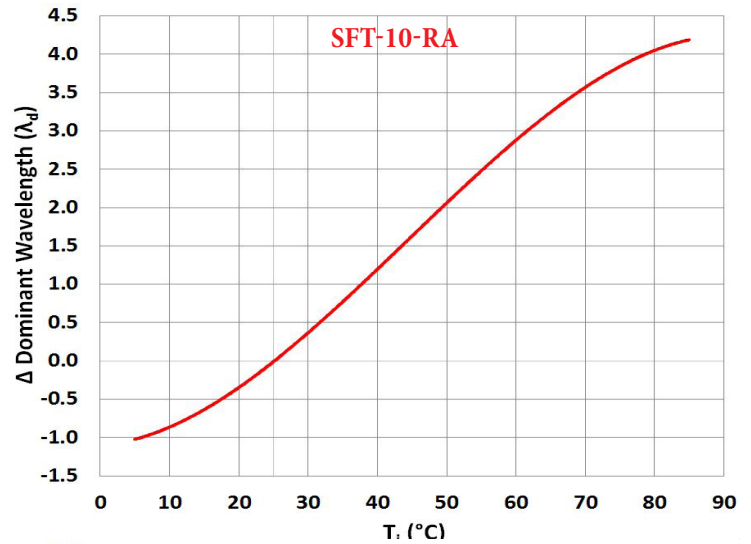
vs. Forward Current ( $T_{hs} = 25^{\circ}\text{C}$ ,  $I_f = \text{Pulse}$ )



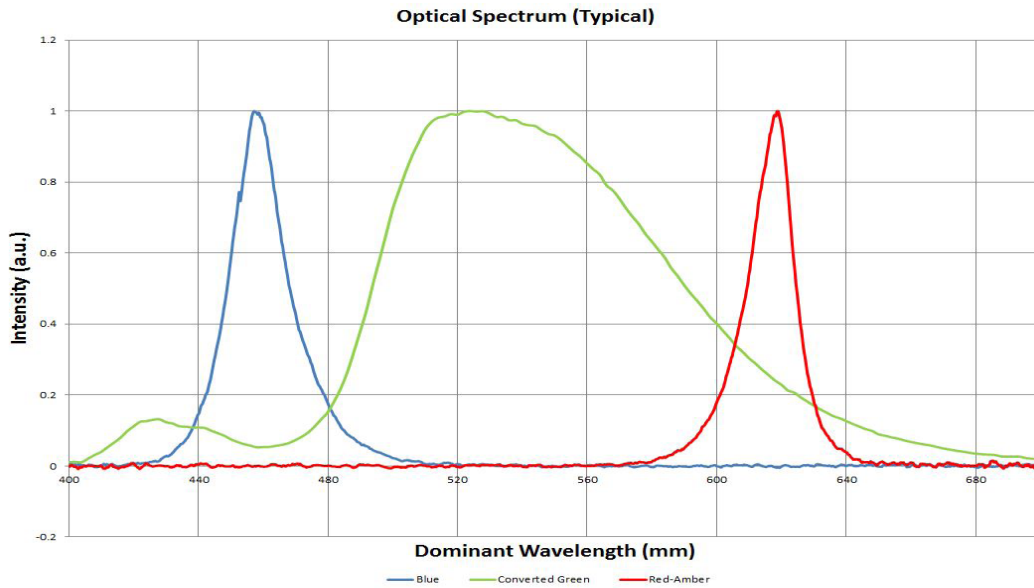
vs.  $T_j$  ( $I_f = 0.7\text{A}$  Pulse)



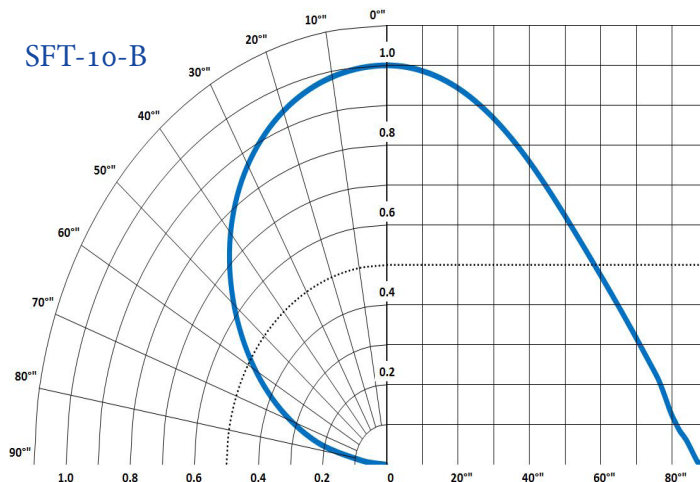
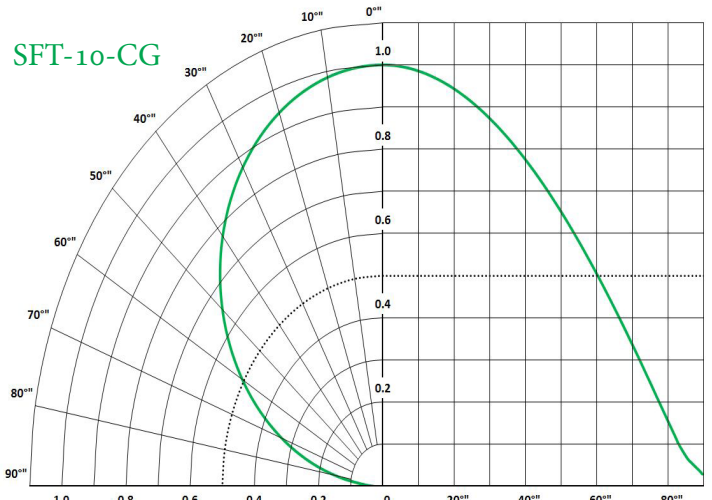
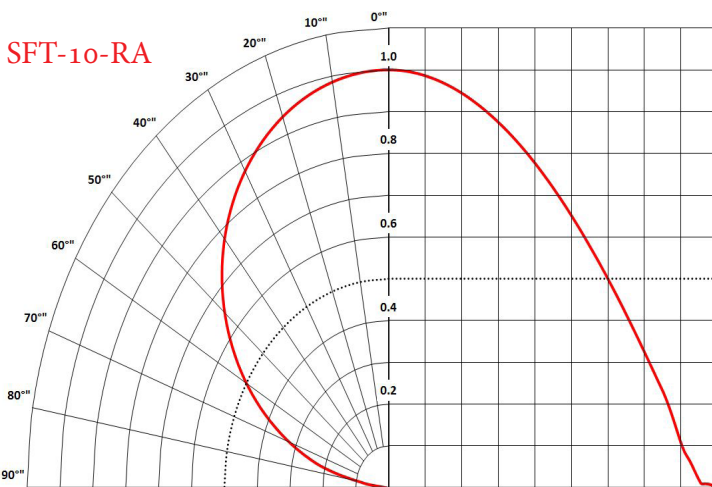
## RELATIVE DOMINANT WAVELENGTH

**vs. Forward Current ( $T_{hs} = 25^\circ\text{C}$ ,  $I_f = \text{Pulse}$ )**

**vs.  $T_j$  ( $I_f = 0.7\text{A}$  Pulse)**


### SFT-Series Optical Spectrum (Typical)<sup>1</sup>

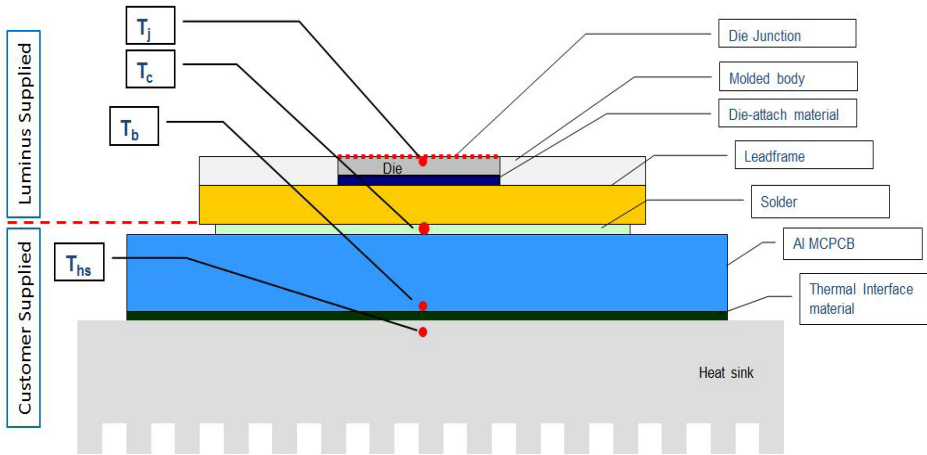


### Angular Intensity Distribution (Typical)<sup>1</sup>



Note 1: Data is recorded using standard test conditions and tolerances as described on page 6.

## Thermal Resistance



### Typical Thermal Resistance

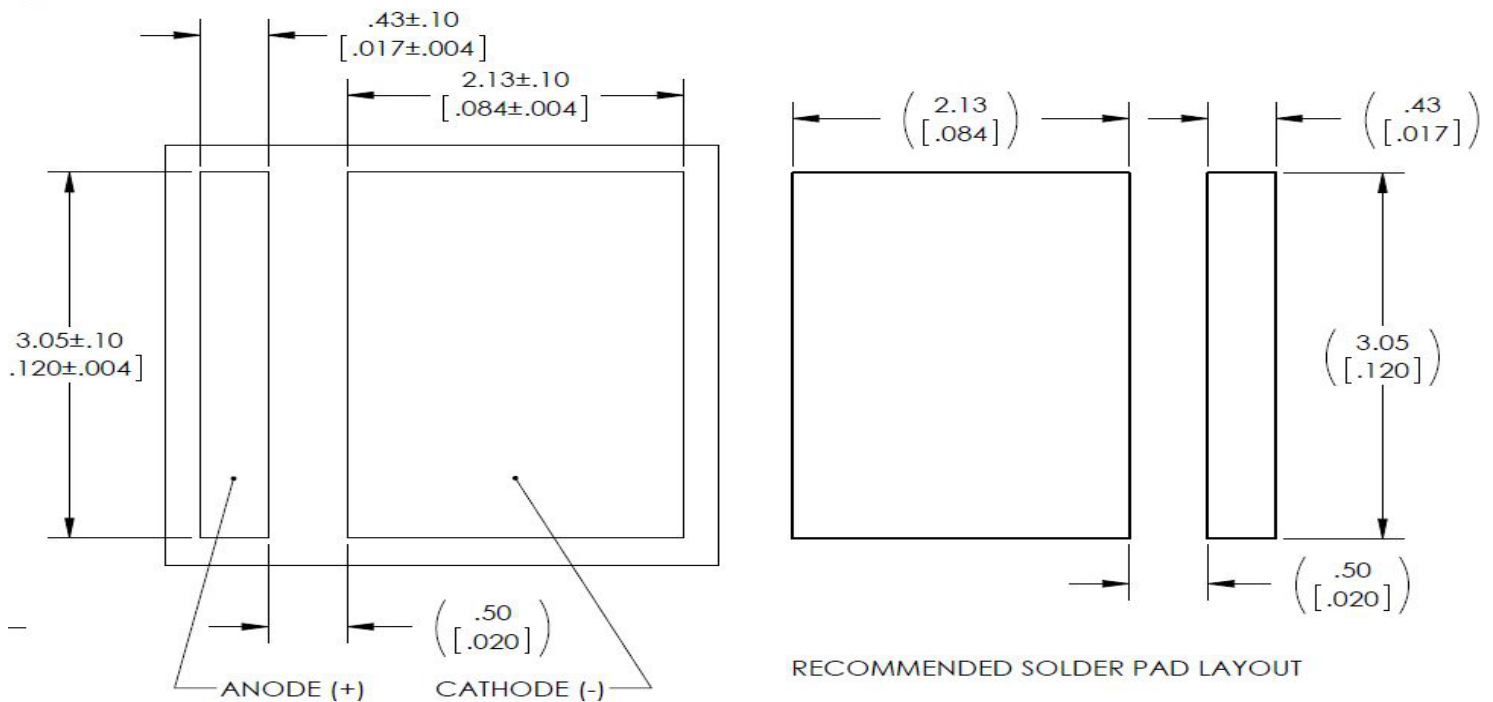
$R_{J-C}^{1,2}$	3.0° C/W
-----------------	----------

Note 1: Thermal resistance values are based on FEA model results correlated to measured  $R_{th-j-hs}$  data.

Note 2: System Thermal Characteristics will be dependent on customer-side thermal strategy.

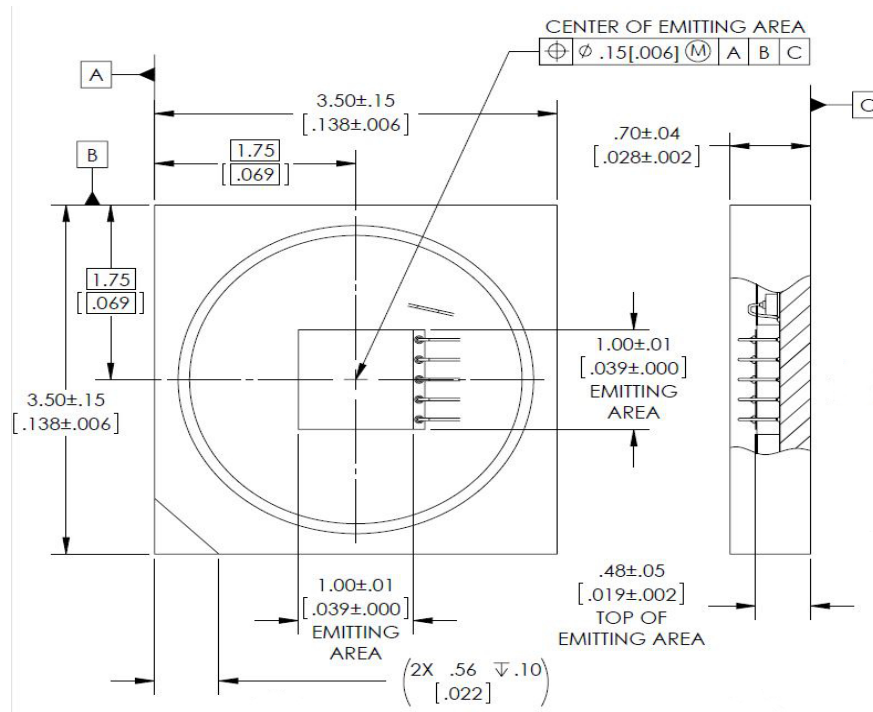
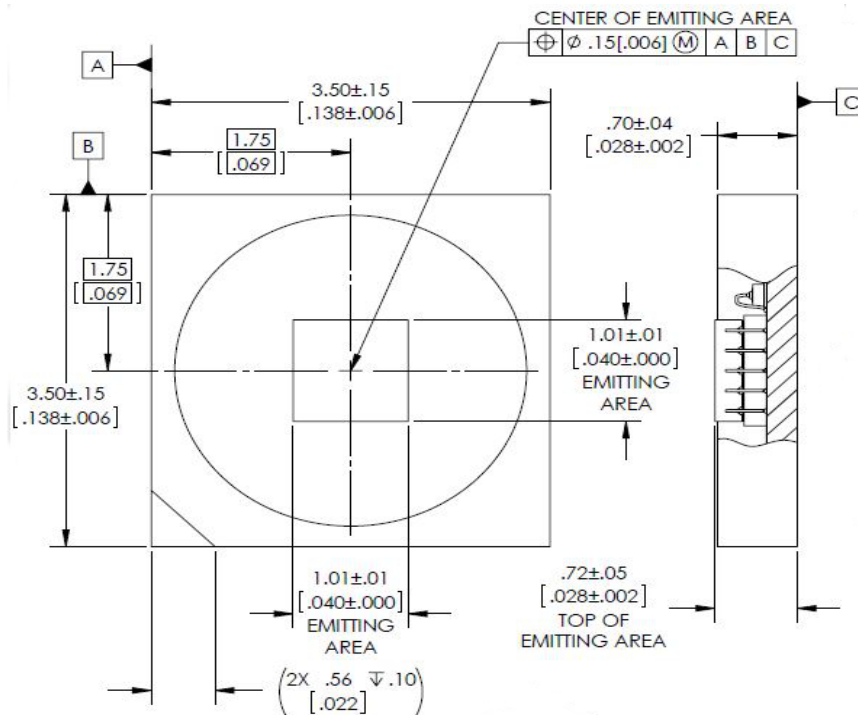
Note 3: For optimal results, Luminus recommends customer PCB Design in accordance with suggestion provided by the Luminus application note, "Design Guidelines for SFT Chipset Assembly".

## Electrical Pinout / Solder Pad Layout



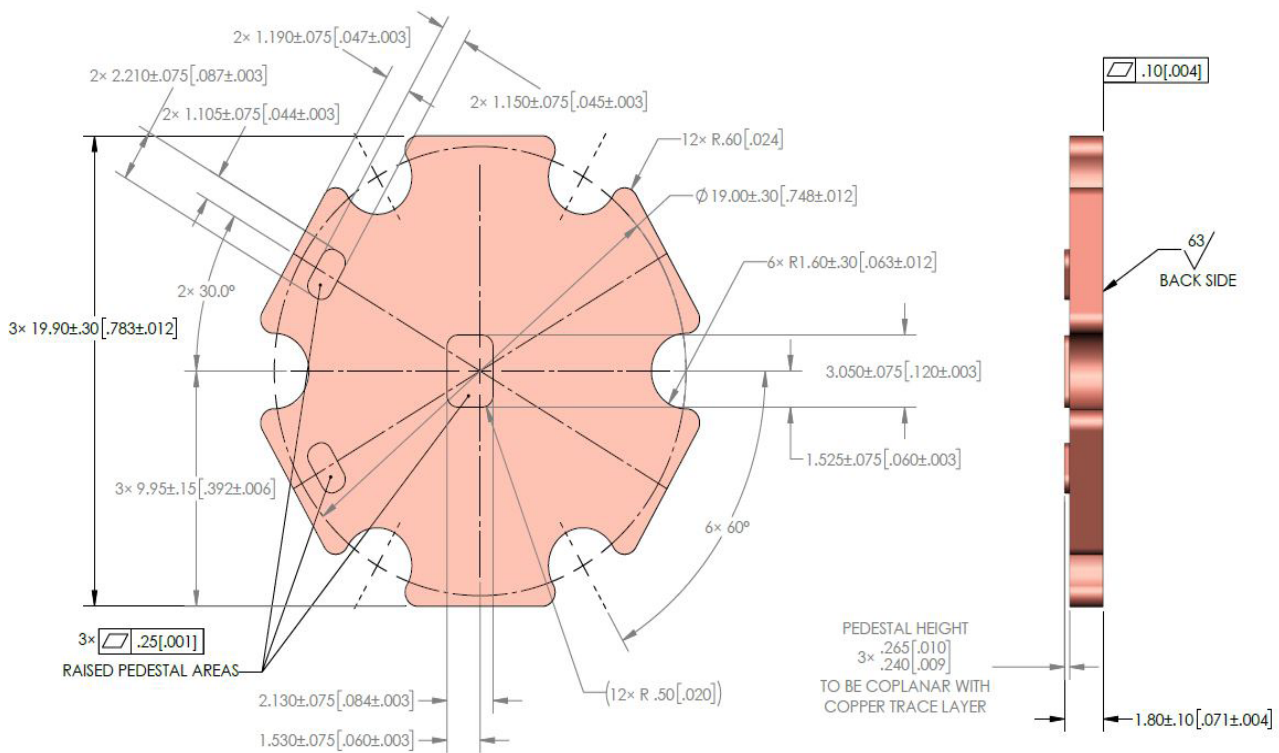
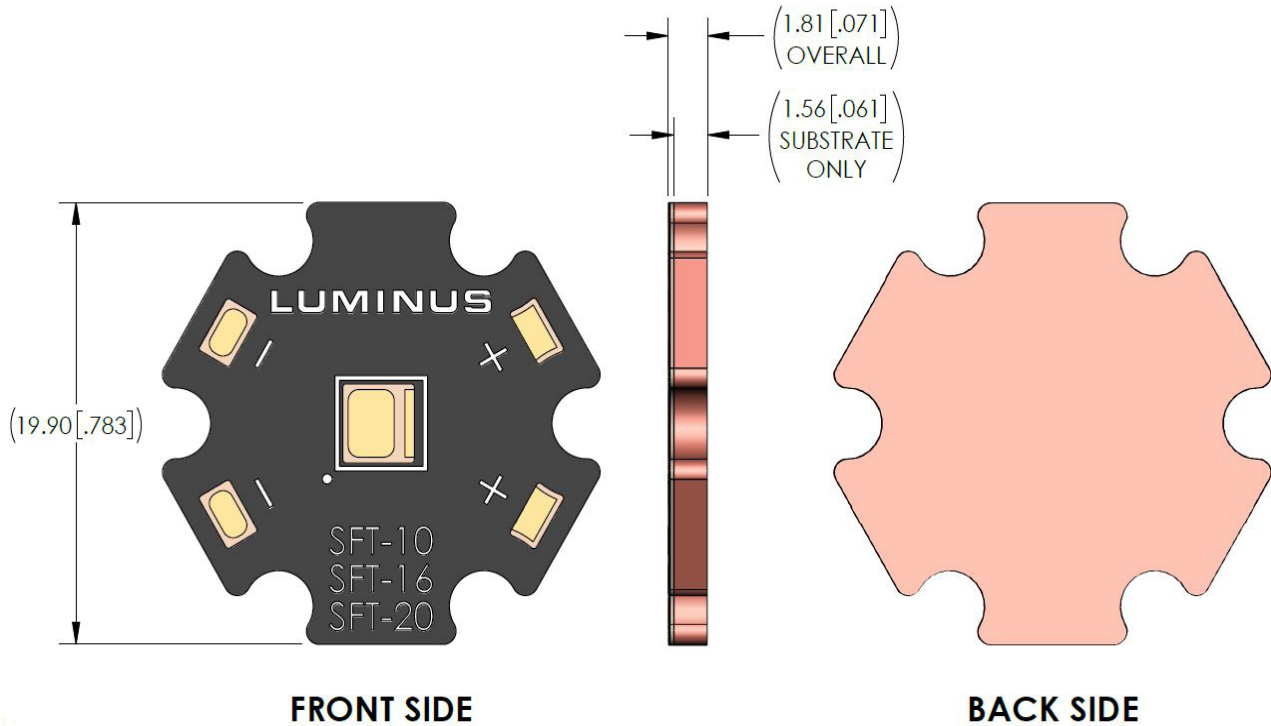
Note: Layout is common to all colors.  
For recommended solder profiles, see page 16

Optimal LED performance is dependent on a proper system design. Please review the Luminus application note, "Design Guidelines for SFT Chipset Assembly." Contact Luminus for more detail.

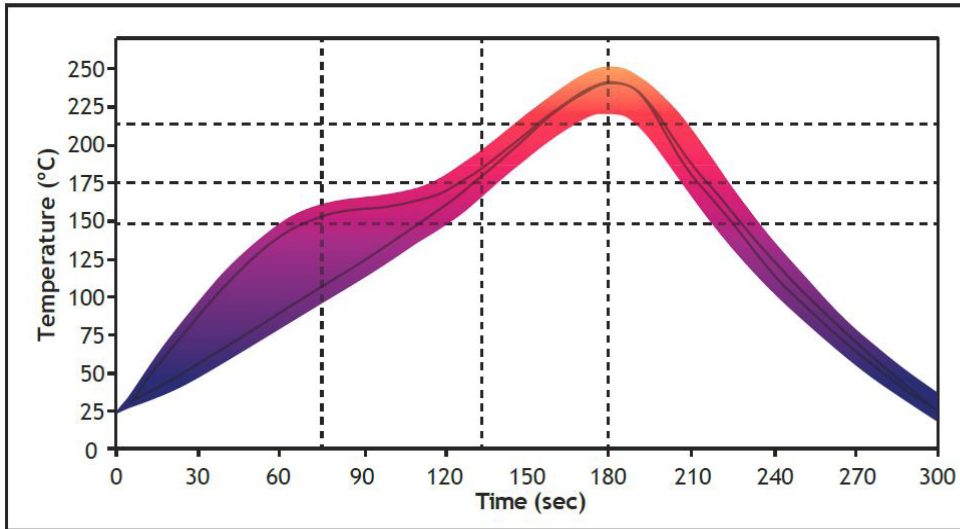
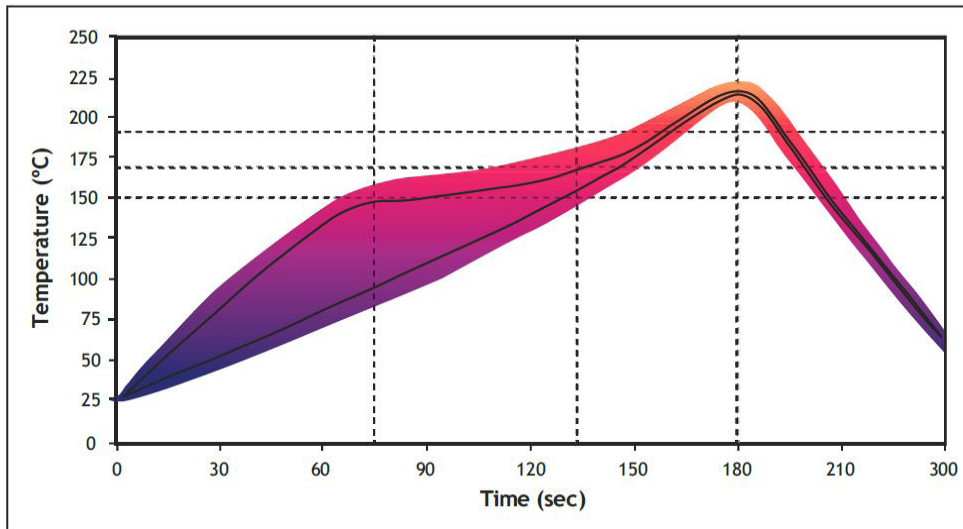
**Mechanical Dimensions - SFT-10 [Red / Blue]**

**Mechanical Dimensions - SFT-10 [Converted Green]**


Notes: Converted Green differs from RED/BLUE in only the emitting surface is slightly larger than the underlying die.



**Mechanical Dimensions - "Starboard" Package Configuration**


**Notes:**  
 Dimensions shown are of bare Starboard. For full detail, please see DWG 400845 available from your local Luminus representative or web site.  
 This Starboard is not electrically isolated. It is active and connected to the LED cathode.  
 Starboard requires electrical isolation in most customer designs. Please see application note APN

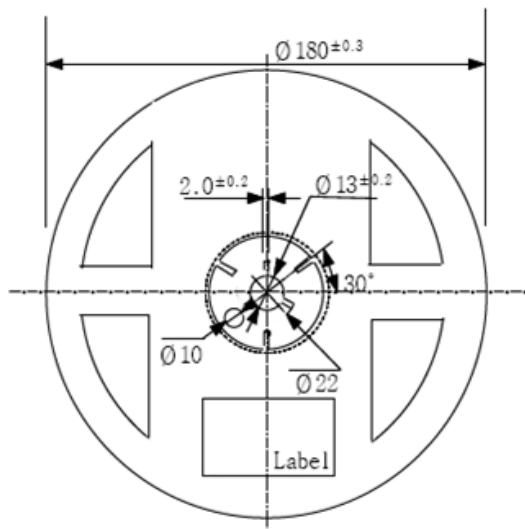
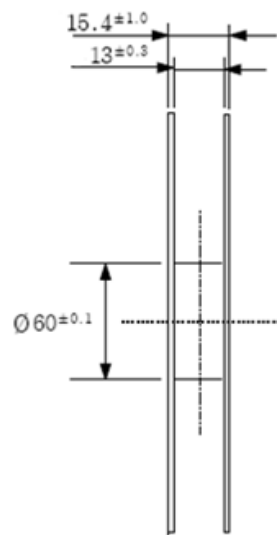
**SOLDER PROFILE INFORMATION**

*SAC305 Solder Profile Graph*

*Sn63 & Sn62 Solder Profile Graph*

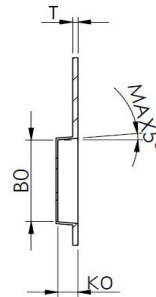
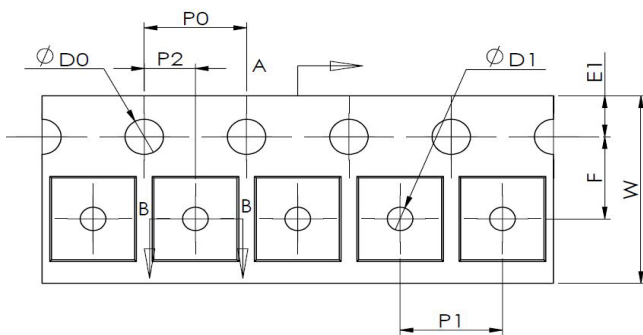
SAC 305 and Sn63 & Sn62 Solder Profile			
Feature	SAC 305	Sn63 & Sn62	Unit
Ramp Up Rate Ambient to Preheat (min)	1.15	1	Degrees Celsius Per Second (°C/s)
Preheat Temperature	175	150	Degrees Celsius (°C)
Profile Length (Preheat to Peak)	165-210	165-210	Seconds (s)
Ramp Up Rate Preheat to Peak (min)	1.5	0.84	Degrees Celsius Per Second (°C/s)
Liquid Temperature	217	183	Degrees Celsius (°C)
Peak Temperature	235	225	Degrees Celsius (°C)
Time Above Liquid Temperature	30-60	30-60	Seconds (s)
Time Within 5C of Peak	20	10	Seconds (s)
Cool down Rate	<4	<4	Degrees Celsius Per Second (°C/s)
Cool Down Duration	30-60	30-60	Seconds (s)
25 C to peak Temperature	180	180	Seconds (s)



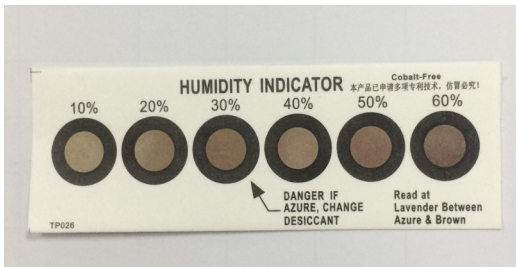
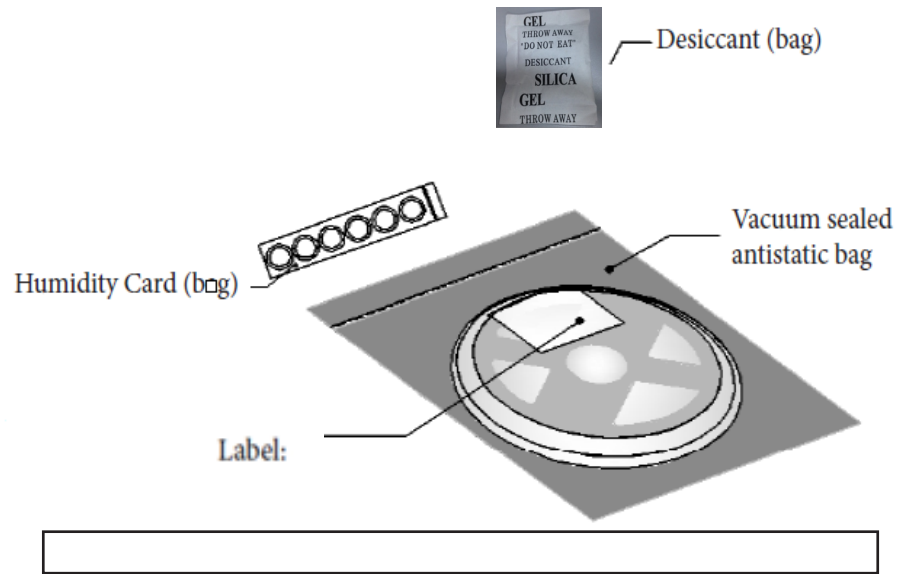
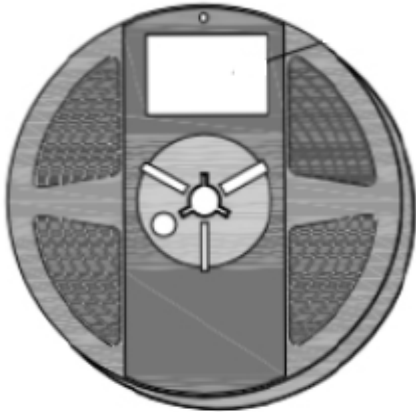
**SHIPPING / PACKAGING INFORMATION**

ITEM	REEL	Box	
		PACKING SPEC	BOX DIMENSION
PACKAGING	250 PCS / REEL	5 REELS PER BOX = 1250 PCS PER BOX	225 X 245 X 65MM


**REEL DIAGRAM**

**TAPE DIMENSIONING DIAGRAM AND TABLE**

**BOX DIAGRAM**


DIMENSION	SPEC (MM)
AO	3.80 +/- 0.10
Bo	4.00 +/- 0.10
Ko	1.20 +/- 0.10
PO	4.00 +/- 0.10
P1	8.00 +/- 0.10
P2	2.00 +/- 0.05
T	0.30 +/- 0.05
E1	1.75 +/- 0.10
F	5.50 +/- 0.05
Do	1.55 +/- 0.05
D1	1.55 +/- 0.05
W	12.00 +/- 0.01

**REEL PACKAGING**

**HUMIDITY CARD**

THE HUMIDITY INDICATOR IS INCLUDED WITHIN EACH ANTI-STATIC BAG. IF HUMIDITY INDICATOR IS TRIGGERED REPLACE DESICCANT AND/OR PRE-BAKE PRIOR TO SYSTEM ASSEMBLY.

LDI RECOMMENDS ALL SFT-SERIES LED ARE STORED "SEALED" UNTIL TIME OF USE. SEE APPLICATION NOTE.

**LABEL**

**CPN:** SFT-10-B-F35

**MPN:** 113148

**QTY:** 250

**Label Fields:**

- **CPN:** Customer orderable Part Number (as defined on P3)
- **MPN:** Manufacturer Part Number (Internal Luminus use)
- **QTY:** Quantity of Devices
- **Bin/Flux:** Flux Bin
- **Bin/Voltage:** Vf Bin (Internal Luminus use)
- **Bin/Color:** Color or Wavelength
- **MFG INFO:** Luminus Internal Use

BIN INFO	
Flux:	4A
Voltage:	V1
Color:	B

MFG INFO
Rev: 01
Lot#: TOR-1607034

RoHS Compliant

## History of Changes

Rev		Description of Change
1	07/21/2017	Release version Removed "Preliminary" Updated flux and wavelength bin tables
2	11/22/2017	Ordering information updated

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